1		DESCRIPTION	OF REVIS	IONS	BY	CHKD	DATE		cou	NT I	DESCRIPTION C	FREVISIONS	BY	CHKD	DAT	Ε
\triangle									7							
Δ		_							7							
4PF	PLICA	BLE STAN	IDARD													
		OPERATING TEMPERATUR	E RANGE	-35	°C .	TO +	85 °C(N	OTE1	IST I) TE	ORAC	GE RATURE RANGE	-10 °C ⁻	TO +	-60 °C	(NOTE	E2)
		OPERATING HUMIDITY RAN		STO						ORAC	RAGE 40% TO 709				%	
DΔ	TING	VOLTAGI	AI					PPLICABLE ONNECTOR DF6- * P-3.9			6C					
IVA	TINO			ANA/O 40 . FA					PLICA	LIL 4007: AVAC 49		R TO	22			
CURREN		CURRENT								ABLE	(APPLICABLE SPROCK		ET HOLI			
			AWG 20 : 4A AWG 22 : 3A						Ф1.8 ТО Ф1.95			5)				
			·	<u> </u>	A			-10	A T16	<u> </u>						
	<u> </u>		<u> </u>				PECIF	-IC/	AIIC	אוכ		LUDENIEN	TO		ТОТ	A T
		EM			TES	I ME	THOD				REG	UIREMEN	118		QT	ΑI
		RUCTION	IVISHALI	Y ANI	BYM	IFASI	RING INS	TRUM	IFNT	IAC	CORDING TO	DRAWING.			Τ×	×
MARKING				VISUALLY AND BY MEASURING INST CONFIRMED VISUALLY.							- I DIVINIO.				^ x	×
															^	
INSULATION				RACTERISTICS 500 V DC. 1000 MΩ MIN.										T _×		
RESISTANCE									٠,,,	NO FLASHOVER OR BREAKDOWN.					<u> </u>	
VOLTAGE PROOF			1500 V AC FOR 1 min.								FLASHOVER	OK BKEAKD	OVVN.		×	
		IICAL CHA								1.			•			
STICKING-BY-PRESSURE PART RESISTANCE			100 mA	100 mA (DC OR 1000Hz).							mΩ MAX.				×	
	RATION						SINGLE A		TUDE		DAMAGE, CI	RACK AND LO	OSEN	NESS,	×	_
DAM	IP HEAT	<u> </u>	0.75 mm, AT 2 h FOR 3 DIRECTIONS. EXPOSED AT 40±2 °C, 90 TO 95 %, 96 h.							1	PARTS. DAMAGE, CI	RACK AND LC	OSEN	NESS,	 	
(STE	EADY S	TATE)									PARTS.				×	
		NMENTAL							0.25.0	, INIC	DAMAGE, CI	DACK AND LC)OSEN	IESS		Ε
RAPID CHANGE OF TEMPERATURE										ا ۔	F PARTS.	VACK AND LC	JUSEI	NESS,	×	_
RESISTANCE TO SOLDERING HEAT			1) AUTOMATIC SOLDERING (FLOW) SOLDER TEMPERATURE, 250±5℃ FOR IMMERSION, DURATION, 10 sec. 2) MANUAL SOLDERING SOLDERING IRON TEMPERATURE :290±10℃, SOLDERING TIME : 3 sec. NO STRENGTH ON CONTACT.							E)	D DEFORMATI KCESSIVE LOC ERMINALS.				×	
,			<u>.</u>	F RISE	BY CU	RRENT		FOR	DRAV		DESIGNED	CHECKED		ROVED	RELE	ASED
NOTI NOTI	E2:APPL' UNUS BOAR APPLI ess ot l	JOING THE TEM Y TO THE CO ED PRODUCT ID, OPERATING IED FOR INTER THE TWISE SPE Qualification Temporery	ONDITION TS BEFORE TEMPERA LIM STORAGE Ecified, re	OF LO E PCB ATURE GE DUR efer to	ONG TON ING TENDERS TO THE PROPERTY OF THE PRO	BOARD HUMID RANSPO C 540	, AFTER INTY RANGE ORTATION.	PCB IS		suki 1.16	H-Umehara '04-04.16		J. 6	Oma 14.16		
NOTI NOTI	E1:INCLU E2:APPL` UNUS BOAR APPLI ess ot l	Y TO THE CO ED PRODUCT D,OPERATING ED FOR INTER DETWISE SPE Qualification To	ONDITION TS BEFORE TEMPERA LIM STORAC ecified, re est AT: A	OF LO E PCB ATURE GE DUR efer to	ONG TON ING THE ING TH	BOARD HUMIDI RANSPO C 540 st ×	, AFTER INTY RANGE ORTATION. O2. Applicable	PCB : IS ,	<u> </u>		PART	1O.			(0.5)
Unic Note	E1:INCLU E2:APPL` UNUS BOAR APPLI ess ot l	Y TO THE CO ED PRODUCT D,OPERATING IED FOR INTER DERWISE SPE Qualification To	ONDITION TS BEFORE TEMPERA TEM	OF LO E PCB ATURE GE DUR efer to	ONG TOOM ON ING THE ONE OF THE ON	BOARD HUMIDI RANSPO C 540 st ×	, AFTER INTY RANGE ORTATION.	PCB : IS ,	<u> </u>	SHI	PART				(05) 1 /